

Micrograf



Cover Type:	Foam rubber
Possible applications:	Pressure roll for gluing in splicer
Recommended Cover Thickness:	min. 10 mm - max. 40 mm
Temperature resistance:	Dry: continuous 80°C / peak 90°C Wet: continuous 70°C / peak 80°C
Properties and advantages:	Very high flexibility Constant Elasticity Perfect flatness of the gluing Elimination of air bubbles when gluing
Chemical resistance:	Acid solutions: Not suited Alkaline solutions: Not suited Hot water and steam: Not suited Ozone: Good Oil and grease: Not suited Aromatic solvents (toluene, benzene,...): Not suited Chlorinated solvents: Not suited Polar solvents (MEC, ether, acetate,...): Not suited
Recommended cleaning products:	Water and compatibles solvents